

# HI-1573, HI-1574

June 2017

MIL-STD-1553 3.3V Monolithic Dual Transceivers

# DESCRIPTION

The HI-1573 and HI-1574 are low power CMOS dual transceivers designed to meet the requirements of the MIL-STD-1553 specification.

The transmitter section of each bus takes complementary CMOS/TTL Manchester II bi-phase data and converts it to differential voltages suitable for driving the bus isolation transformer. Separate transmitter inhibit control signals are provided for each transmitter.

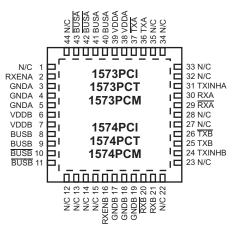
The receiver section of the each bus converts the 1553 bus bi-phase differential data to complementary CMOS / TTL data suitable for input to a Manchester decoder. Each receiver has a separate enable input, which forces the receiver outputs to logic "0" (HI-1573) or logic "1" (HI-1574).

To minimize the package size for this function, the transmitter outputs are internally connected to the receiver inputs, so that only two pins are required for connection to each coupling transformer. For designs requiring independent access to transmitter and receiver 1553 signals, please contact your Holt Sales representative.

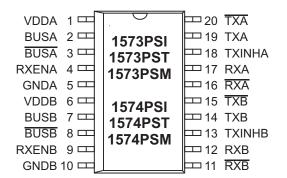
# FEATURES

- Compliant to MIL-STD-1553A and B, ARINC 708A
- 3.3V single supply operation
- Smallest footprint available in 7 mm x 7 mm 44- pin plastic chip-scale package (QFN)
- Less than 0.5W maximum power dissipation
- Available in DIP and small outline (ESOIC) package options
- Industrial and extended temperature ranges
- Industry standard pin configurations

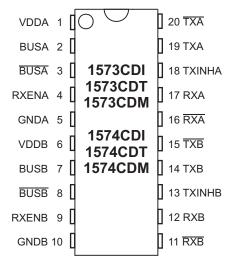
# **PIN CONFIGURATIONS**



#### 44 Pin Plastic 7mm x 7mm Chip-scale package (QFN)



#### 20 Pin Plastic ESOIC - WB package



#### 20 Pin Ceramic DIP package

#### HI-1573, HI-1574

#### **PIN DESCRIPTIONS**

PIN (DIP & SOIC)	SYMBOL	FUNCTION	DESCRIPTION
1	VDDA	power supply	+3.3 volt power for transceiver A
2	BUSA	analog	MIL-STD-1533 bus driver A, positive signal
3	BUSA	analog	MIL-STD-1553 bus driver A, negative signal
4	RXENA	digital input	Receiver A enable. If low, forces RXA and RXA low (HI-1573) or High (HI-1574)
5	GNDA	power supply	Ground for transceiver A
6	VDDB	power supply	+3.3 volt power for transceiver B
7	BUSB	analog	MIL-STD-1533 bus driver B, positive signal
8	BUSB	analog	MIL-STD-1553 bus driver B, negative signal
9	RXENB	digital input	Receiver B enable. If low, forces RXB and RXB low (HI-1573) or High (HI-1574)
10	GNDB	power supply	Ground for transceiver B
11	RXB	digital output	Receiver B output, inverted
12	RXB	digital output	Receiver B output, non-inverted
13	TXINHB	digital input	Transmit inhibit, bus B. If high BUSB, BUSB disabled
14	TXB	digital input	Transmitter B digital data input, non-inverted
15	TXB	digital input	Transmitter B digital data input, inverted
16	RXA	digital output	Receiver A output, inverted
17	RXA	digital output	Receiver A output, non-inverted
18	TXINHA	digital input	Transmit inhibit, bus A. If high BUSA, BUSA disabled
19	TXA	digital input	Transmitter A digital data input, non-inverted
20	TXA	digital input	Transmitter A digital data input, inverted

### FUNCTIONAL DESCRIPTION

The HI-1573 family of data bus transceivers contains differential voltage source drivers and differential receivers. They are intended for applications using a MIL-STD-1553 A/B data bus. The device produces a trapezoidal output waveform during transmission.

#### TRANSMITTER

Data input to the device's transmitter section is from the complementary CMOS inputs TXA/B and TXA/B. The transmitter accepts Manchester II bi-phase data and converts it to differential voltages on BUSA/B and BUSA/B. The transceiver outputs are either direct- or transformer-coupled to the MIL-STD-1553 data bus. Both coupling methods produce a nominal voltage on the bus of 7.5 volts peak to peak.

The transmitter is automatically inhibited and placed in the high impedance state when both TXA/B and TXA/B are driven with the same logic state. A logic "1" applied to the TXINHA/B input will force the transmitter to the high impedance state, regardless of the state of TXA/B and TXA/B.

#### RECEIVER

The receiver accepts bi-phase differential data from the MIL-STD-1553 bus through the same direct- or transformer-coupled interface as the transmitter.

The receiver's differential input stage drives a filter and threshold comparator that produces CMOS data at the RXA/B and  $\overline{RXA/B}$  output pins. When the MIL-STD-1553 bus is idle and RXENA or RXENB are high, RXA/B will be logic "0" on HI-1573 and logic "1" on HI-1574.

The receiver outputs are forced to the bus idle state (logic "0" on HI-1573 or logic "1" on HI-1574) when RXENA or RXENB is low.

#### **MIL-STD-1553 BUS INTERFACE**

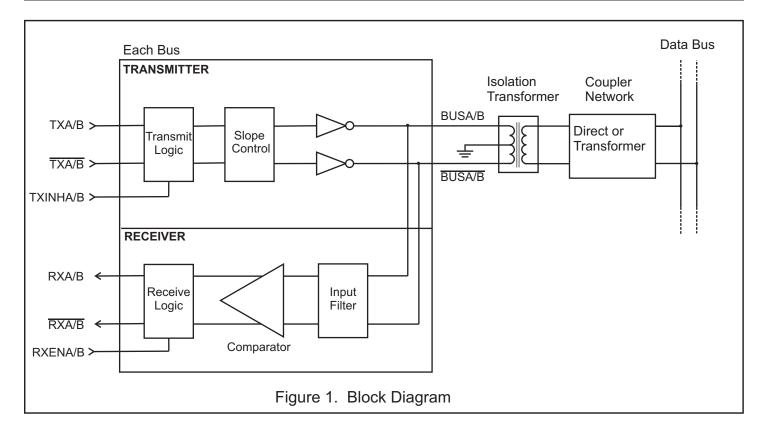
A direct-coupled interface (see Figure 2) uses a 1:2.5 ratio isolation transformer and two 55 ohm isolation resistors between the transformer and the bus. The primary center-tap of the isolation transformer must be connected to GND.

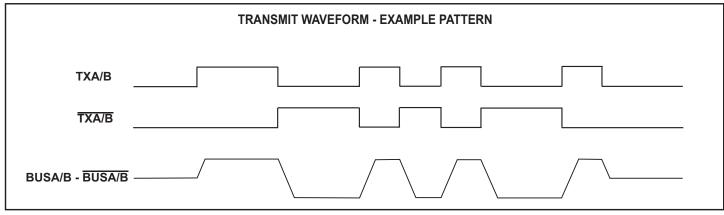
In a transformer-coupled interface (see Figure 2), the transceiver is connected to a 1:1.79 isolation transformer which in turn is connected to a 1:1.4 coupling transformer. The transformer-coupled method also requires two coupling resistors equal to 75% of the bus characteristic impedence (Zo) between the coupling transformer and the bus.

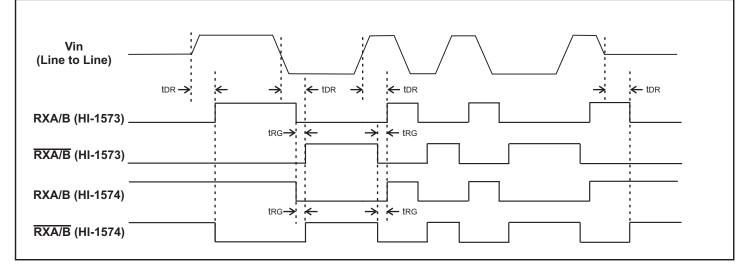
Figure 3 and Figure 4 show test circuits for measuring electrical characteristics of both direct- and transformercoupled interfaces respectively. (See electrical characteristics on the following pages).

HOLT INTEGRATED CIRCUITS

HI-1573, HI-1574







#### HOLT INTEGRATED CIRCUITS

#### **ABSOLUTE MAXIMUM RATINGS**

Supply voltage (VDD)	-0.3 V to +5 V			
Logic input voltage range	-0.3 V dc to +3.6 V			
Receiver differential voltage	50 Vp-p			
Driver peak output current	+1.0 A			
Power dissipation at 25°C ceramic DIL, derate	1.0 W 7mW/°C			
Solder Reflow Temperature	260°C			
Junction Temperature	175°C			
Storage Temperature	-65°C to +150°C			

#### **RECOMMENDED OPERATING CONDITIONS**

Supply Voltage	
VDD	3.3V ±5%
Temperature Range	

Industrial	40°C to +85°C
Extended	55°C to +125°C

NOTE: Stresses above absolute maximum ratings or outside recommended operating conditions may cause permanent damage to the device. These are stress ratings only. Operation at the limits is not recommended.

## **DC ELECTRICAL CHARACTERISTICS**

VDD = 3.3 V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

PARAMETER	SYMBOL	CONDITION	MIN	ТҮР	MAX	UNITS
Operating Voltage	VDD		3.15	3.30	3.45	V
Total Supply Current	ICC1	Not Transmitting		10	17	mA
	ICC2	Transmit one bus @ 50% duty cycle		210	225	mA
	ICC3	Transmit one bus @ 100% duty cycle		420	450	mA
Power Dissipation	PD1	Not Transmitting		0.033	0.060	W
	PD2	Transmit one bus @ 100% duty cycle		0.475	0.55	W
Min. Input Voltage (HI)	Vih	Digital inputs	70%			VDD
Max. Input Voltage (LO)	VIL	Digital inputs			30%	VDD
Min. Input Current (HI)	Ін	Digital inputs			20	μA
Max. Input Current (LO)	lı∟	Digital inputs	-20			μA
Min. Output Voltage (HI)	Vон	louτ = -1.0mA, Digital outputs	90%			VDD
Max. Output Voltage (LO)	Vih	louτ = 1.0mA, Digital outputs			10%	VDD
RECEIVER (Measured at Point "AD" in F	igure 3 unles	s otherwise specified)				
Input resistance	Rin	Differential (at chip pins)	20			Kohm
Input capacitance	CIN	Differential			5	pF
Common mode rejection ratio	CMRR		40			dB
Input Level	VIN	Differential			9	Vp-p
Input common mode voltage	VICM		-5.0		5.0	V-pk
Threshold Voltage - Direct-coupled Detect	Vthd	1 Mhz Sine Wave Measured at Point "Ab" in Figure 3 RXA/B, RXA/B pulse width >70 ns	1.15			Vp-p
No Detect	VTHND	No pulse at RXA/B, RXA/B			0.28	Vp-p
Theshold Voltage - Transformer-coupled Detect	Vthd	1 MHz Sine Wave Measured at Point "At" in Figure 4 RXA/B, RXA/B pulse width >70 ns	0.86			Vp-p
No Detect	Vthnd	No pulse at RXA/B, RXA/B			0.20	Vp-p

# DC ELECTRICAL CHARACTERISTICS (cont.)

VDD = 3.3 V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

	PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
TRANSMITTER	(Measured at Point "AD" in Fi	gure 3 unless	otherwise specified)				
Output Voltage	Direct coupled	Vout	35 ohm load (Measured at Point "Aɒ" in Figure 3)	6.0		9.0	Vp-p
	Transformer coupled	Vout	70 ohm load (Measured at Point "Ατ" in Figure 4)	18.0		27.0	Vp-p
Output Noise		Von	Differential, inhibited			10.0	mVp-p
Output Dynamic C	Dffset Voltage Direct coupled	Vdyn	35 ohm load (Measured at Point "Aɒ" in Figure 3)	-90		90	mV
	Transformer coupled	Vdyn	70 ohm load (Measured at Point "Ατ" in Figure 4)	-250		250	mV
Output resistance		Rout	Differential, not transmitting	10			Kohm
Output Capacitan	се	Соит	1 MHz sine wave			15	pF

### **AC ELECTRICAL CHARACTERISTICS**

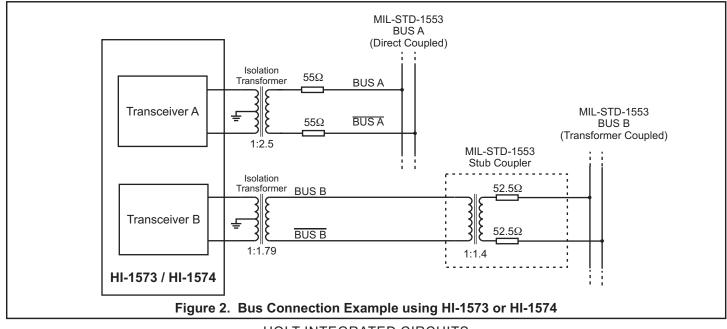
VDD = 3.3 V, GND = 0V, TA =Operating Temperature Range (unless otherwise specified).

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS			
RECEIVER (Measured at Point "AT" in Figure 4)									
Receiver Delay	tDR	From input zero crossing to RXA/B or RXA/B			500	ns			
					Note 3				
Receiver gap time	trg	Spacing between RXA/B and RXA/B pulses	60		430	ns			
			Note 1		Note 2				
Receiver Enable Delay	tren	From RXENA/B rising or falling edge to			40	ns			
		RXA/B or RXA/B			40	115			
TRANSMITTER (Measured	at Point "AD"	in Figure 3)							
Driver Delay	tdт	TXA/B, TXA/B to BUSA/B, BUSA/B			150	ns			
Rise time tr		35 ohm load	100		300	ns			
Fall Time	tf	35 ohm load	100		300	ns			
Inhibit Delay tDI-н		Inhibited output			100	ns			
	tDI-L	Active output			150	ns			

Note 1. Measured using a 1 MHz sinusoid, 20 V peak to peak, line to line at point "AT" (Guaranteed but not tested).

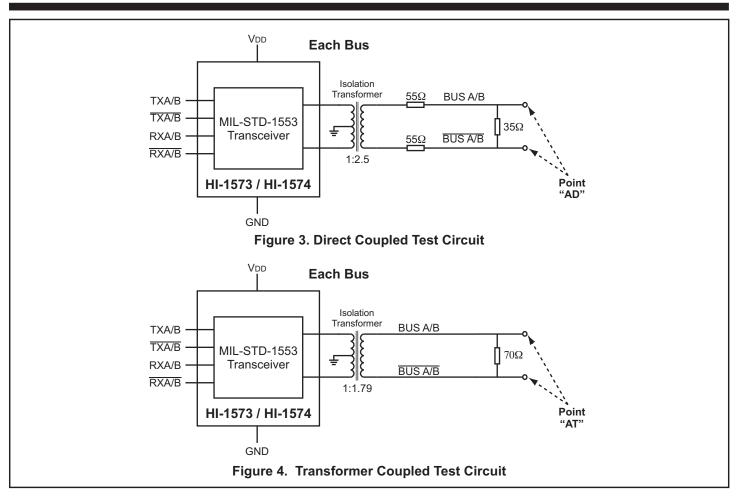
Note 2. Measured using a 1 MHz sinusoid, 860 mV peak to peak, line to line at point "AT" (100% tested).

Note 3. Measured using a 1 MHz sinusoid, 860 mV peak to peak, line to line at point "AT". Measured from input zero crossing point.



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HI-1573, HI-1574



#### HEAT SINK - ESOIC PACKAGE

Both the HI-1573PSI/T/M and HI-1574PSI/T/M use a 20-pin APPLICATIONS NOTE thermally enhanced SOIC package. The HI-1573PCI/T/M and HI-1574PCI/T/M use a plastic chip-scale package (QFN). These packages include a metal heat sink located on the bottom surface of the device. This heat sink should be soldered down to the printed circuit board for optimum thermal dissipation.

& CHIP-SCALE The heat sink is electrically isolated and may be soldered to any convenient power or ground plane.

Holt Applications Note AN-500 provides circuit design notes regarding the use of Holt's family of MIL-STD-1553 transceivers. Layout considerations, as well as recommended interface and protection components are included.

#### THERMAL CHARACTERISTICS

PART NUMBER	PACKAGE STYLE	CONDITION	Ø <sub>JA</sub>	JUNCTION TEMPERATURE			
PART NUMBER	PACKAGE STILE	CONDITION	ØJA	T <sub>A</sub> =25°C	T <sub>A</sub> =85°C	T <sub>A</sub> =125°C	
HI-1573PSI / T / M	20-pin Thermally enhanced plastic SOIC	Heat sink unsoldered	54°C/W	52°C	112°C	152°C	
HI-1574PSI / T / M	(ESOIC)	Heat sink soldered	47°C/W	49°C	109°C	149°C	
HI-1573CDI / T / M HI-1574CDI / T / M	20-pin Ceramic side-brazed DIP	Socketed	62°C/W	56°C	116°C	156°C	
HI-1573PCI / T / M HI-1574PCI / T / M	44-pin Plastic chip- scale package (QFN)	Heat sink unsoldered	49°C/W	50°C	110°C	150°C	

Data taken at VDD=3.3V, continuous transmission at 1Mbit/s, single transmitter enabled.

#### **ORDERING INFORMATION**

# HI - <u>157x xx x x</u> (Plastic)

	PART NUMBER	PACK DESC	AGE RIPTION				
	Blank	Tin / L	ead (Sn /	Pb) Solo	ler		
	F	100%	Matte Tin	(Pb-free	e RoHS c	ompliant)	
	PART NUMBER		ERATUR E	_	LOW	BURN IN	
	I	-40°C	TO +85°(	C	I	No	
	Т	-55°C	-55°C TO +125°C		Т	No	
	М	-55°C	TO +125	°C	М	Yes	
	PART NUMBER	PACK DESC	AGE RIPTION				
	PC	44 PIN	I PLASTI	C CHIP-	SCALE F	ACKAGE	RFN (44PCS)
	PS	20 PIN	I PLASTI	C ESOI	C, Therm	ally Enhanc	ed Wide SOIC w/Heat Sink (20HWE)
	PART	RXE	NA = 0	RXEN	B = 0		
	NUMBER	RXA	RXA	RXB	RXB		
	1573	0	0	0	0		
	1574	1	1	1	1		

# HI - <u>157xCD x</u> (Ceramic)

	PART NUMBER	TEMPI RANG	ERATUR E		FLOW		BURN IN	LEAD FINISH	
	I	-40°C	TO +85°0		I		No	Gold (Pb-free, RoHS compliant)	
	Т	-55°C TO +125°C		°C	т		No	Gold (Pb-free, RoHS compliant)	
	М	-55°C TO +125°C		°C	М		Yes	Tin / Lead (Sn / Pb) Solder	
	PART	RXENA = 0 RXENB = 0 PACKAGE							
	NUMBER	RXA	RXA	RXB	RX	В	DESCR	IPTION	
	1573	0	0	0	0		20 PIN CERAMIC SIDE BRAZED DIP (20C)		
	1574	1	1	1	1		20 PIN CERAMIC SIDE BRAZED DIP (20C)		

#### **RECOMMENDED TRANSFORMERS**

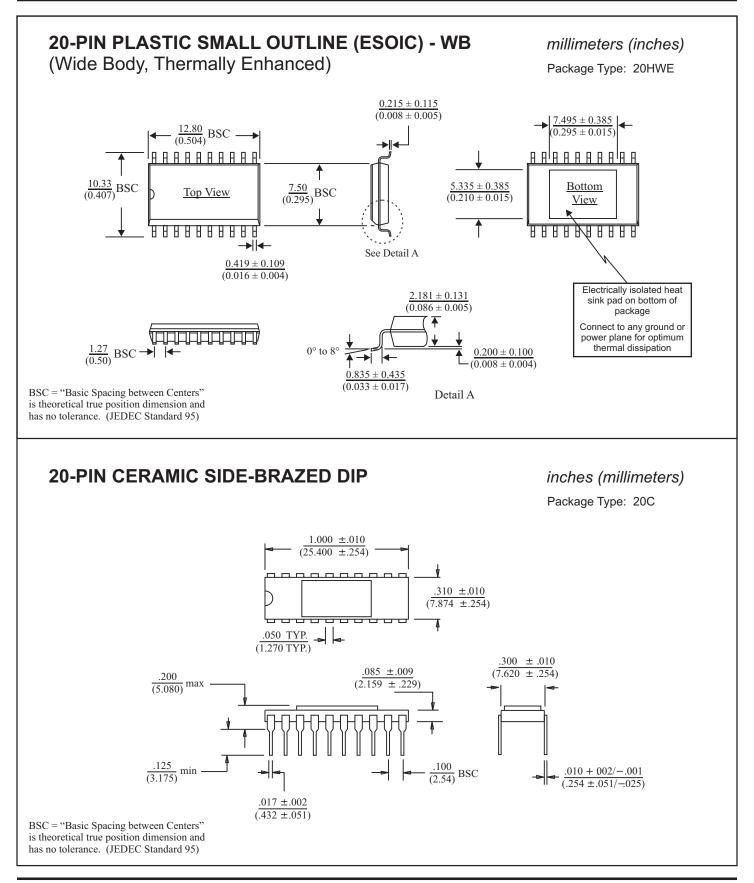
The HI-1573 and HI-1574 transceivers have been characterized for compliance with the electrical requirements of MIL-STD-1553 when used with the following

transformers. Holt recommends the Premier Magnetics parts as offering the best combination of electrical performance, low cost and small footprint.

MANUFACTURER	PART NUMBER	APPLICATION	TURNS RATIO(S)	DIMENSIONS
Premier Magnetics	PM-DB2725EX	Isolation	Dual ratio 1:1.79, 1:2.5	0.4 x 0.4 x 0.242 inches
Premier Magnetics	PM-DB2702	Stub coupling	1:1.4	.625 x .625 x .250 inches
Premier Magnetics	PM-DB-2791S	Isolation	1:2.5	0.4 x 0.4 x 0.185 inches
Premier Magnetics	PM-DB-2795S	Isolation	1:1.79	0.4 x 0.4 x 0.185 inches
Premier Magnetics	PM-DB-2798S	Isolation	Dual ratio 1:1.79, 1:2.5	0.4 x 0.4 x 0.185 inches
Premier Magnetics	PM-DB-2762	Isolation	Dual core 1:2.5	0.4 x 0.4 x 0.320 inches
Premier Magnetics	PM-DB-2766	Isolation	Dual core 1:1.79	0.4 x 0.4 x 0.320 inches

# **REVISION HISTORY**

Document	Rev.	Date	Description of Change
DS1573	L	09/26/08	Clarification of transmitter and receiver functions in Description, clarification of available temperature ranges, and corrected a dimension in Recommended Transformers table.
	Μ	04/13/09	Add 'M' Flow option to chip-scale package (QFN). Clarify nomenclature of chip-scale package as QFN.
	Ν	07/24/09	Correct typographical errors in package dimensions.
	0	10/13/09	Clarified status of RXA/B and RXA/B pins in bus idle state when RXENA or RXENB are high (logic "1").
	Ρ	01/26/12	Fix typos in tRG and tDT descriptions in AC characteristics table. Added latest Premier Magnetics transformer recommendations. Remove Technotrol transformer recommendations.
	Q	06/20/13	Updated functional description text for clarity. Revised figures 2,3, and 4. Updated package drawings.
	R	05/21/14	Updated Figure 2 and package drawings.
	S	04/09/15	Correct Figures 2 and 3. Other minor clarifications.
	Т	06/06/17	Update Power Dissipation and Power Supply Current parameters.



# HOLT J

